onsemi

<u>MOSFET</u> – P-Channel, QFET[®] -500 V, 4.9 Ω, -2.1 A

FQD3P50

Description

This P-Channel enhancement mode power MOSFET is produced using ON Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

Features

- -2.1 A, -500 V, $R_{DS(on)} = 4.9 \Omega$ (Max.) @ $V_{GS} = -10$ V, $I_D = -1.05$ A
- Low Gate Charge (Typ. 18 nC)
- Low Crss (Typ. 9.5 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

Symbol	Parameter	Value	Unit
V _{DSS}	Drain–Source Voltage	-500	V
Ι _D	Drain Current – Continuous (T _C = 25°C) – Continuous (T _C = 100°C)	-2.1 -1.33	A
I _{DM}	Drain Current – Pulsed (Note 1)	-8.4	А
V _{GSS}	Gate-Source Voltage	±30	V
E _{AS}	Single Pulsed Avalanche Energy (Note 2)	250	mJ
I _{AR}	Avalanche Current (Note 1)	-2.1	А
E _{AR}	Repetitive Avalanche Energy (Note 1)	5.0	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	-4.5	V/ns
PD	Power Dissipation ($T_A = 25^{\circ}C$) (Note 4)	2.5	W
	Power Dissipation (T _C = 25°C) – Derate above 25°C	50 0.4	W W/°C
T _J , T _{STG}	Operating and Storage Temperature Range	–55 to +150	°C
ΤL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300	°C

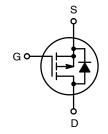
ABSOLUTE MAXIMUM RATINGS (T_C = 20°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

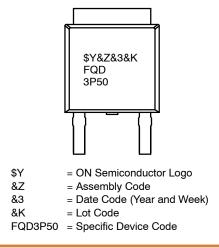
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. L = 102 mH, I_{AS} = -2.1 A, V_{DD} = -50 V, R_G = 25 Ω , Starting T_J = 25°C.
- 3. $I_{SD} \le -2.7$ A, di/dt ≤ 200 A/ms, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}$ C.
- 4. When mounted on the minimum pad size recommended (PCB Mount).



CASE 369AS



MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping [†]
FQD3P50	DPAK3 (Pb-Free)	2,500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

THERMAL CHARACTERISTICS

Symbol	Parameter	FQD3P50	Unit	
Rejc	Thermal Resistance, Junction-to-Case, Max.	2.5	°C/W	
Reja	Thermal Resistance, Junction-to-Ambient, Max. (Note 5)	50	°C/W	
Reja	Thermal Resistance, Junction-to-Ambient, Max.	110	°C/W	

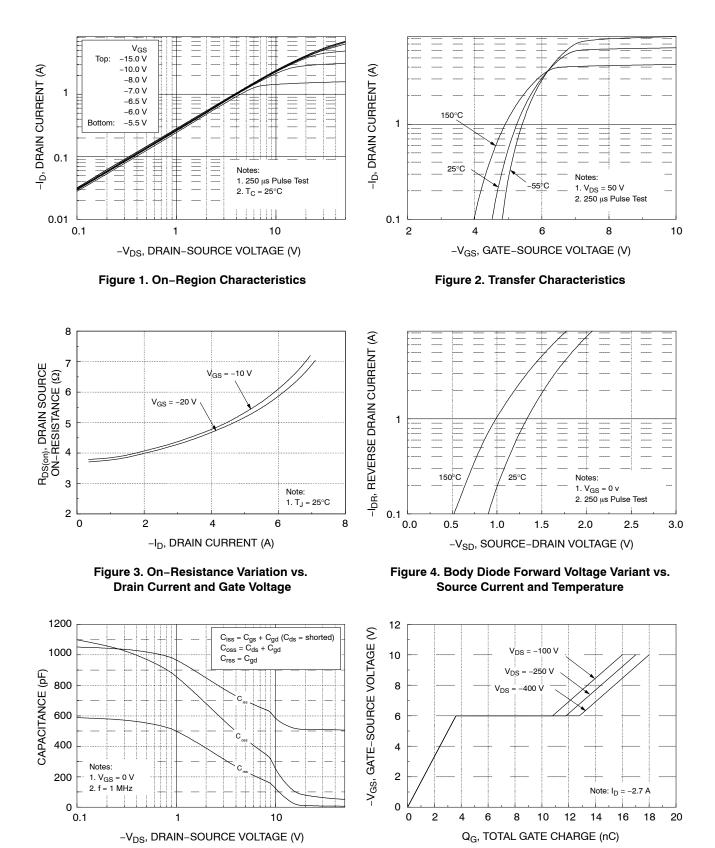
5. When mounted on the minimum pad size recommended (PCB Mount).

ELECTRICAL CHARACTERISTICS (T_C = 25° C unless otherwise noted)

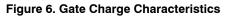
Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit
OFF CHARAC	CTERISTICS			-		
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \text{ mA}$	-500	_	_	V
$\Delta \text{BV}_{\text{DSS}}\!/\!\Delta\text{T}_{\text{J}}$	Breakdown Voltage Temperature Coef- ficient	$I_D = -250$ mA, Referenced to $25^{\circ}C$	-	0.42	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -500 \text{ V}, V_{GS} = 0 \text{ V}$	_	-	-1	μA
		$V_{DS} = -400 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$	-	-	-10	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = -30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	_	-	-100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = 30 V, V _{DS} = 0 V	_	-	100	nA
ON CHARACT	TERISTICS					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250 \text{ mA}$	-3.0	-	-5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = -10 V, I _D = -1.05 A	-	3.9	4.9	Ω
9 FS	Forward Transconductance	V _{DS} = -50 V, I _D = -1.05 A	-	2.1	-	S
DYNAMIC CH	ARACTERISTICS				-	-
C _{iss}	Input Capacitance	$V_{DS} = -25 V, V_{GS} = 0 V,$	_	510	660	pF
C _{oss}	Output Capacitance	f = 1.0 MHz	_	70	90	pF
C _{rss}	Reverse Transfer Capacitance		_	9.5	12	pF
SWITCHING C	CHARACTERISTICS					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = -250 \text{ V}, \text{ I}_{D} = -2.7 \text{ A},$	-	12	35	ns
t _r	Turn-On Rise Time	R _G = 25 Ω (Note 6)	-	56	120	ns
t _{d(off)}	Turn-Off Delay Time		_	35	80	ns
t _f	Turn-Off Fall Time		-	45	100	ns
Qg	Total Gate Charge	$\label{eq:VDS} \begin{array}{l} V_{DS} = -400 \; V, \; I_D = -2.7 \; A, \\ V_{GS} = -10 \; V \\ (Note \; 6) \end{array}$	-	18	23	nC
Q _{gs}	Gate-Source Charge		-	3.6	-	nC
Q _{gd}	Gate-Drain Charge		_	9.2	-	nC
DRAIN-SOUF	RCE DIODE CHARACTERISTICS AND N	AXIMUM RATINGS				
I _S	Maximum Continuous Drain-Source Diode Forward Current		-	-	-2.1	А
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		_	-	-8.4	А
V_{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = -2.1 A	_	-	-5.0	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = -2.7 A, dI _F / dt = 100 A/ms	_	270	_	ns
Q _{rr}	Reverse Recovery Charge		_	1.5	-	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.Essentially independent of operating temperature.

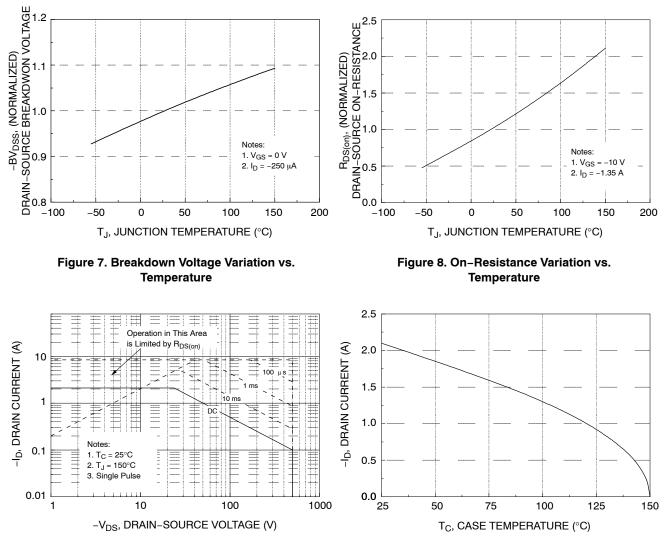
TYPICAL PERFORMANCE CURVES





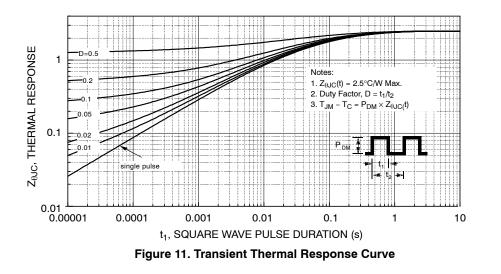


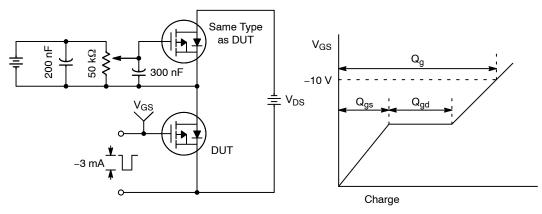
TYPICAL PERFORMANCE CURVES (CONTINUED)













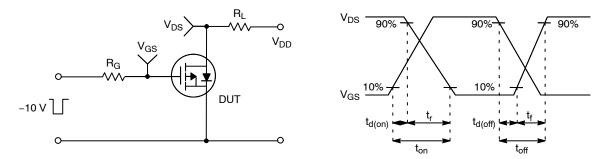


Figure 13. Resistive Switching Test Circuit & Waveforms

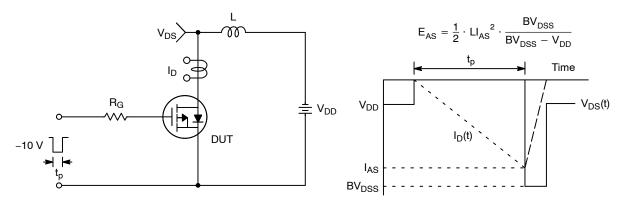


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

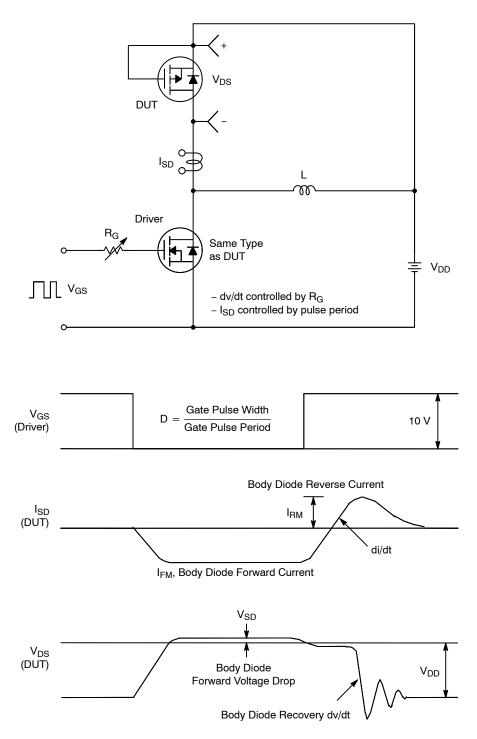
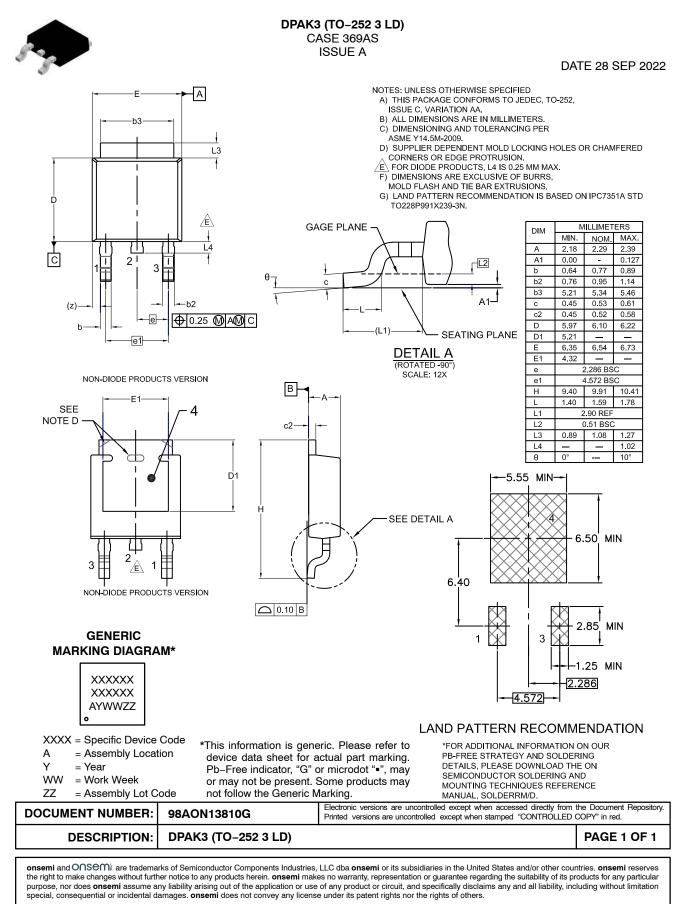


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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